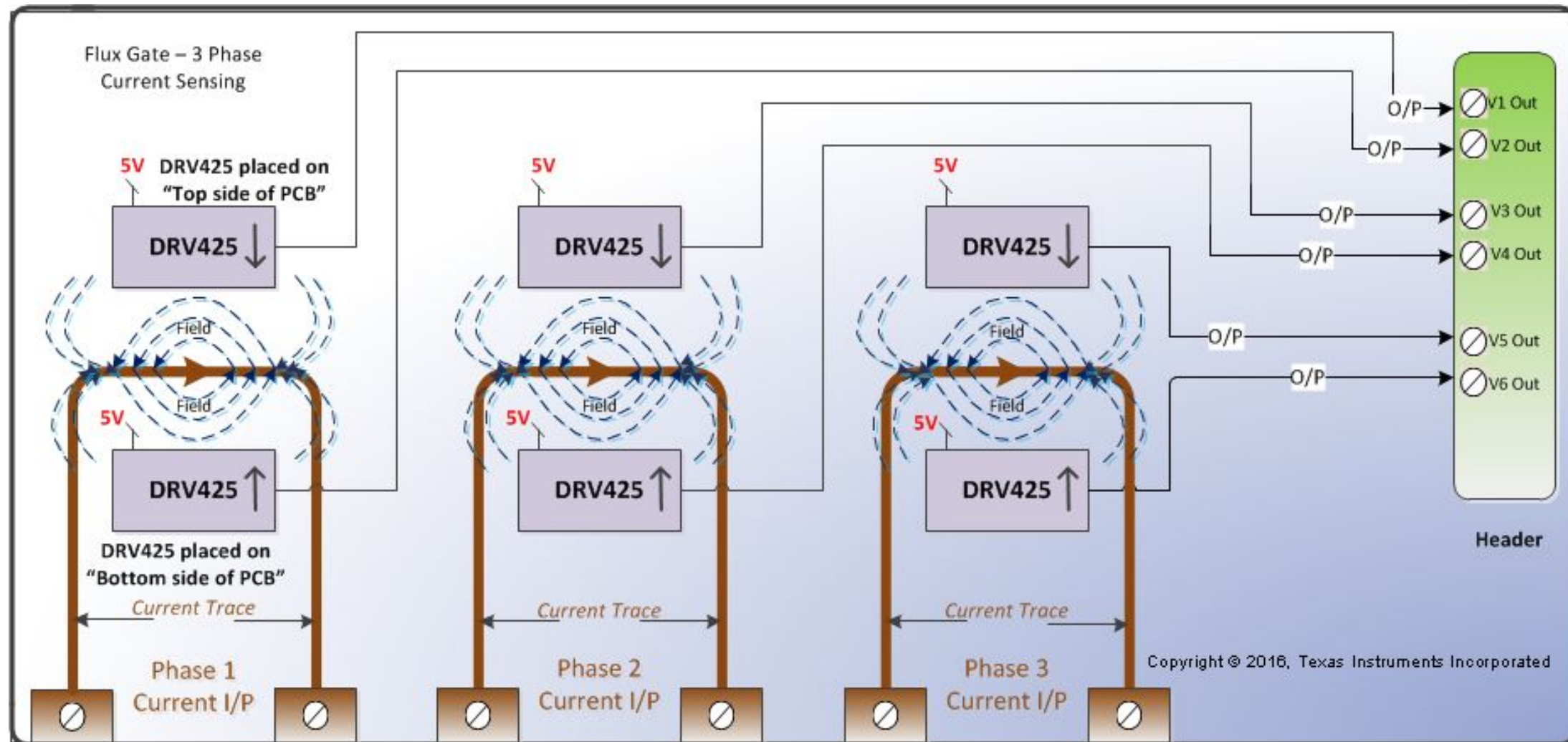
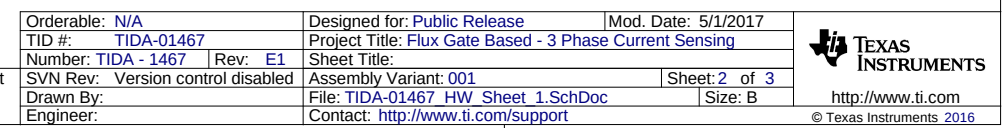
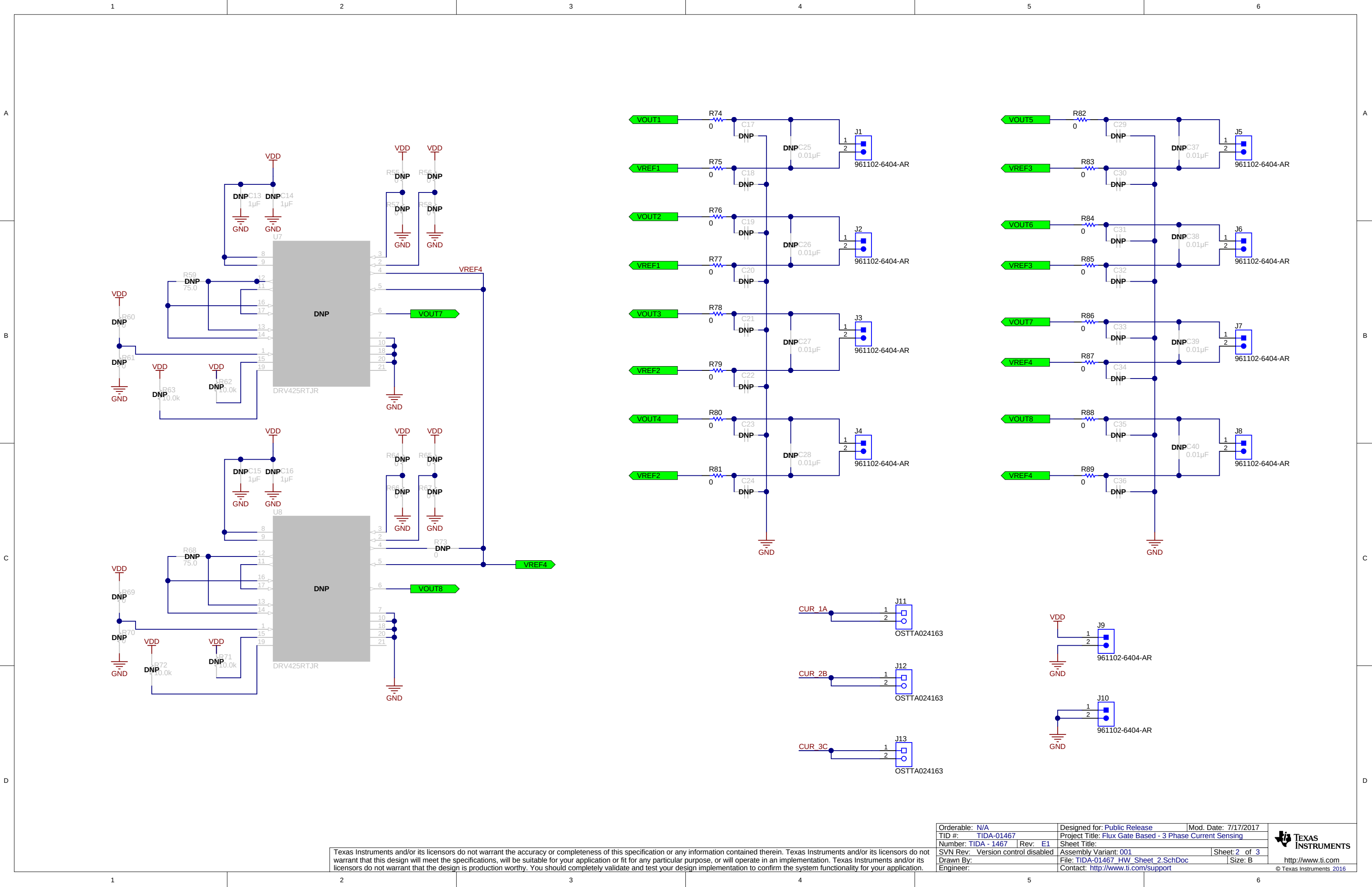


Revision History

Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A







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Orderable: N/A	Designed for: Public Release	Mod. Date: 7/17/2017
TID #: TIDA-01467	Project Title: Flux Gate Based - 3 Phase Current Sensing	
Number: TIDA - 1467	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By:	File: TIDA-01467_HW_Sheet_2.SchDoc	Size: B
Engineer:	Contact: http://www.ti.com/support	

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